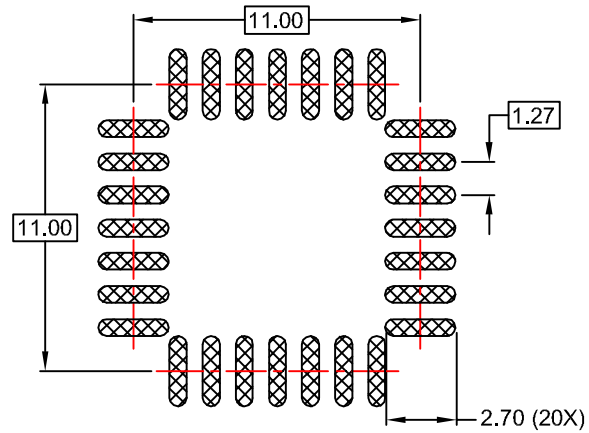
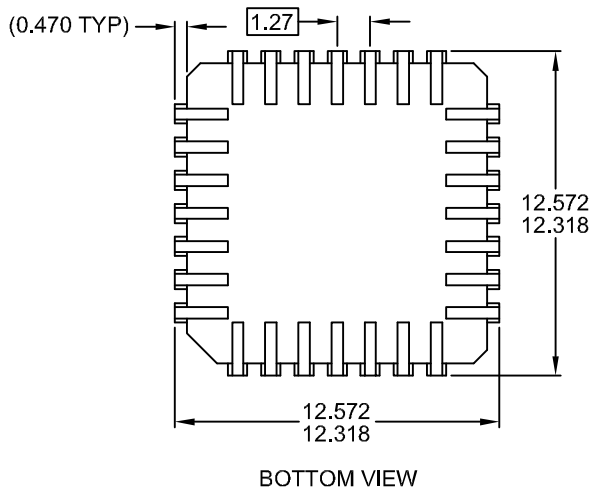
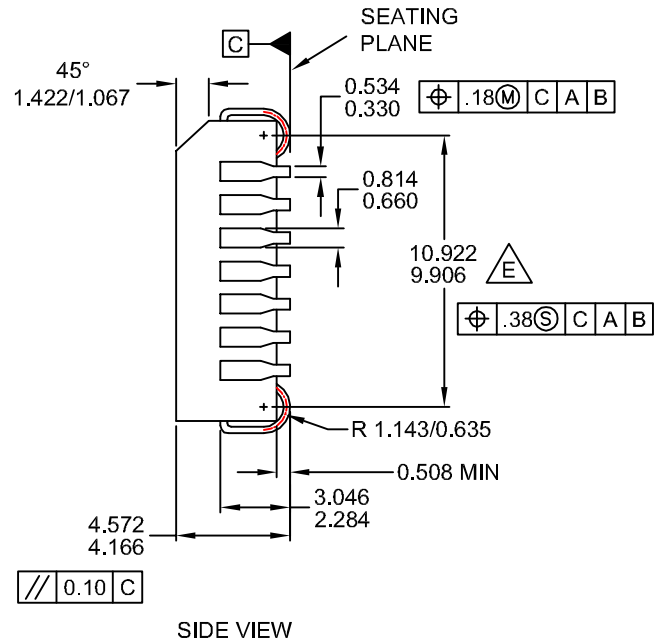
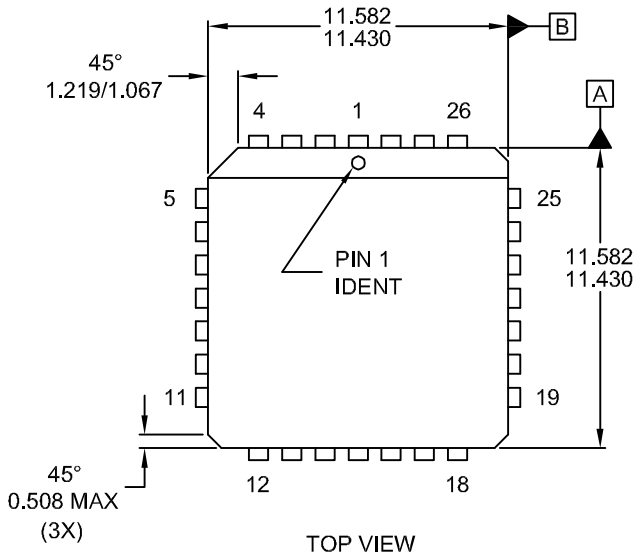


REVISIONS			
REV	DESCRIPTION	DATE	APP'D / SITE
2	Recreated drawing, added landpattern recommendation.	8-3-07	L. Huebener / FSME
3	Spec change to MS-018. Updated landpattern to have rounded ends. Added Pin 1 Ident.	1-16-08	L. Huebener / FSME
4	Recreated drawing to have correct orthographic projection layout. Also redimensioned drawing.	12-4-08	L. England / FSME



NOTES:

- A. THIS PACKAGE CONFORMS TO JEDEC MS-018, VARIATION AB.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR PROTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.
- E. MEASURED AT SEATING PLANE (DATUM C) CONTACT POINT.
- F. LAND PATTERN STANDARD: PLCC127P1244X1244X457-28M.
- G. DRAWING FILENAME: V28Arev4.

APPROVALS		DATE	FAIRCHILD SEMICONDUCTOR™		
DRAWN	L. England	12-04-08	28LD, PLCC, JEDEC MS-018 VARIATION AB, 0.450" SQUARE		
DFTG. CHK.	H. Allen	12-05-08			
ENGR. CHK.					
PROJECTION		SCALE	SIZE	DRAWING NUMBER	REV
		N/A	N/A	MKT-V28A	4
DO NOT SCALE DRAWING				SHEET 1 of 1	